

PolyOne Corporation  
33587 Walker Road  
Avon Lake, OH 44012

PATENT  
Docket No.  
1200323N US

**Notice of Appeal Pursuant To 37 CFR §1.191**

Assistant Commissioner for Patents  
Washington, D.C. 20231

**VIA EFS WEB**

Re: Application of: David A. JARUS, Jeff CICERCHI, Guoqiang QIAN, and Tie LAN

Application No. 10/595,282 G.A.U. 1714 Conf. No. 6688

Filed: April 4, 2006 Examiner: P. Niland

Title: NANOCLAY-CONTAINING COMPOSITES AND METHODS OF  
MAKING THEM

Applicants appeal to the Board of Patent Appeals and Interferences from the Action of the Examiner dated July 12, 2007 and rejecting claims 1-20.

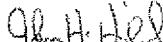
The time to respond to the Action will expire on October 12, 2007.

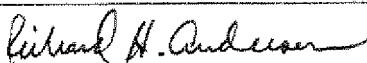
The Fee of \$500 for filing this Notice of Appeal will be charged to Deposit Account No. 07-1077 as a part of the EFS filing process.

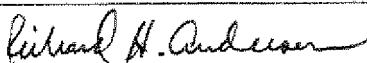
Please charge to Deposit Account 07-1077 any fees under 37 CFR §§1.16 and 1.17 which may be required during the entire pendency of this application. This authorization includes the fee for any extension of time under 37 CFR §1.136(a) that may be necessary. To the extent any such extension should become necessary it is hereby requested.

Respectfully submitted,

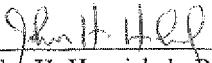
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|-------------------------------|----------------------------------|
| Registration Number<br>29,393 | Telephone Number<br>440-930-3317 |
| Date: September 26, 2007      |                                  |

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| John H. Hornickel  |

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| 26,526                             | 312-474-6300   |
| Date:<br><i>September 27, 2007</i> |  |

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| Richard H. Anderson  |

I hereby certify that this paper is being transmitted to the United States Patent and Trademark Office on the date shown below to the EFS-Web in Private PAIR:

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| October 10, 2007 | Signed<br> |
| Date             | John H. Hornickel, Reg. No. 29,393   |